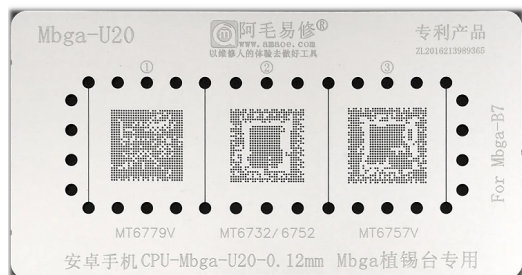


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AMAOE BGA Mbga-U20 stencil reballing CPU MT6779V MT6732/6752 MT6757V 0,12mm for MBGA-B7

Product ID: 23002

Price: **7.00 EUR**

Product weight: **0.20 kg**

Description:

AMAOE BGA Mbga-U20 stencil reballing CPU MT6779V MT6732/6752 MT6757V 0,12mm for MBGA-B7- the sieves are a product made of steel resistant to high temperatures and deformations. Precise laser-cut templates facilitate positioning during work.

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